



KERSEMI

BCR3KM-12

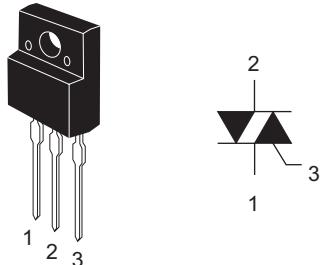
Features

- $I_{T(RMS)}$: 3 A
- V_{DRM} : 600 V
- $I_{FGT\ I}, I_{RG\ T\ I}, I_{RG\ T\ III}$: 15 mA (10 mA)^{Note3}

- Insulated Type
- Planar Passivation Type
- UL Recognized : Yellow Card No. E223904
File No. E80271

Outline

TO-220FN



1. T_1 Terminal
2. T_2 Terminal
3. Gate Terminal

Applications

Electric rice cooker, electric pot, and controller for other heater

Maximum Ratings

Parameter	Symbol	Voltage class		Unit
		12		
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	600		V
Non-repetitive peak off-state voltage ^{Note1}	V_{DSM}	720		V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_{T(RMS)}$	3.0	A	Commercial frequency, sine full wave 360° conduction, $T_c = 111^\circ C$
Surge on-state current	I_{TSM}	30	A	60Hz sinewave 1 full cycle, peak value, non-repetitive
I^2t for fusing	I^2t	3.7	A^2s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P_{GM}	3	W	
Average gate power dissipation	$P_{G(AV)}$	0.3	W	
Peak gate voltage	V_{GM}	6	V	
Peak gate current	I_{GM}	0.5	A	
Junction temperature	T_j	- 40 to +125	$^\circ C$	
Storage temperature	T_{stg}	- 40 to +125	$^\circ C$	
Mass	—	2.0	g	
Isolation voltage	V_{iso}	2000	V	$T_a = 25^\circ C$, AC 1 minute, $T_1 \cdot T_2 \cdot G$ terminal to case

Notes: 1. Gate open.

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak off-state current	I_{DRM}	—	—	2.0	mA	$T_j = 125^\circ C$, V_{DRM} applied
On-state voltage	V_{TM}	—	—	1.5	V	$T_c = 25^\circ C$, $I_{TM} = 4.5$ A, Instantaneous measurement
Gate trigger voltage ^{Note2}	I	$V_{FGT\ I}$	—	1.5	V	$T_j = 25^\circ C$, $V_D = 6$ V, $R_L = 6$ Ω , $R_G = 330$ Ω
	II	$V_{RGT\ I}$	—	1.5	V	
	III	$V_{RGT\ III}$	—	1.5	V	
Gate trigger current ^{Note2}	I	$I_{FGT\ I}$	—	15 ^{Note3}	mA	$T_j = 25^\circ C$, $V_D = 6$ V, $R_L = 6$ Ω , $R_G = 330$ Ω
	II	$I_{RGT\ I}$	—	15 ^{Note3}	mA	
	III	$I_{RGT\ III}$	—	15 ^{Note3}	mA	
Gate non-trigger voltage	V_{GD}	0.2	—	—	V	$T_j = 125^\circ C$, $V_D = 1/2V_{DRM}$
Thermal resistance	$R_{th(j-c)}$	—	—	4.0	$^\circ C/W$	Junction to case ^{Note4}
Thermal resistance	$R_{th(c-a)}$	—	—	50	$^\circ C/W$	Junction to ambient

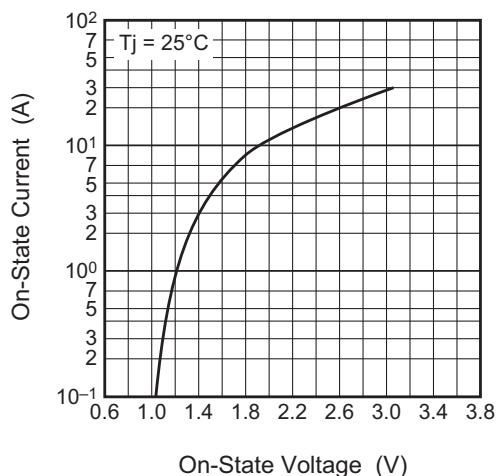
Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

3. High sensitivity ($I_{GT} \leq 10$ mA) is also available. (I_{GT} item: 1)

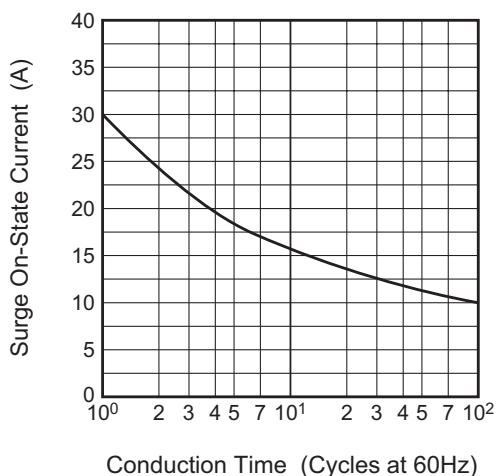
4. The contact thermal resistance $R_{th(c-f)}$ in case of greasing is $0.5^\circ C/W$.

Performance Curves

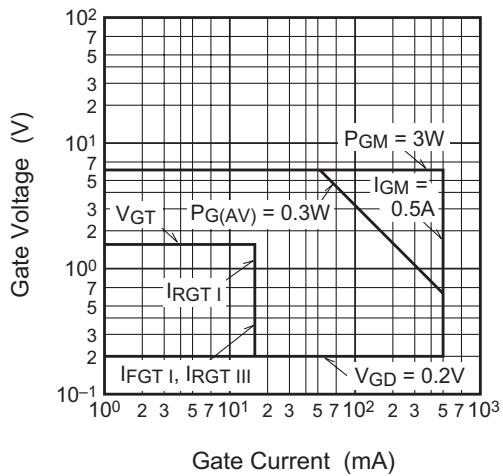
Maximum On-State Characteristics



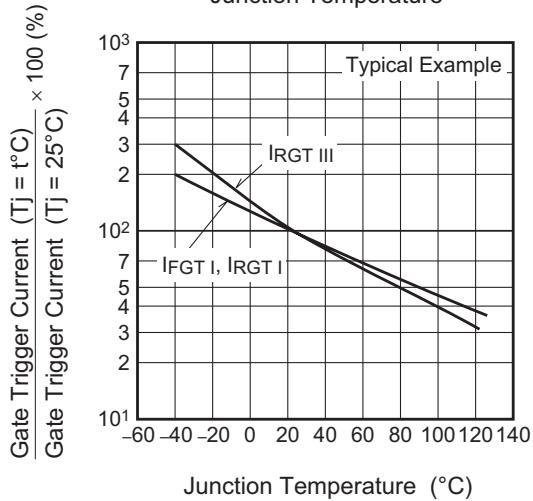
Rated Surge On-State Current



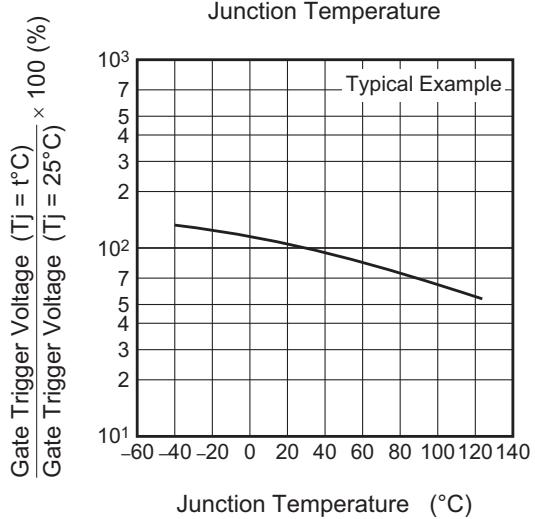
Gate Characteristics (I, II and III)



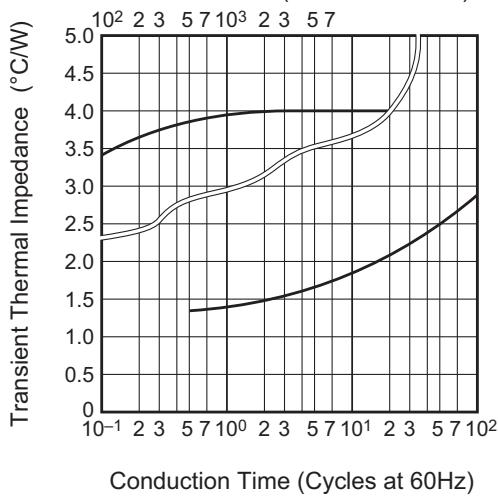
Gate Trigger Current vs. Junction Temperature



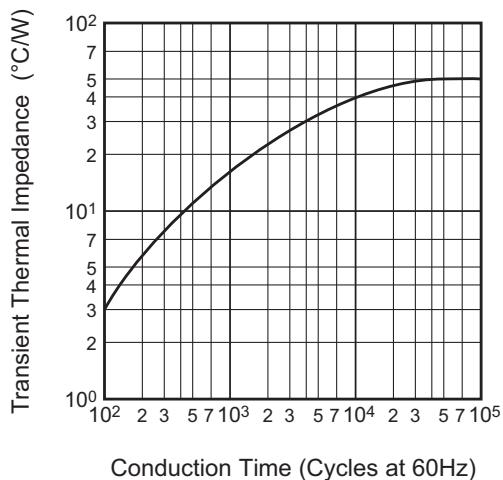
Gate Trigger Voltage vs. Junction Temperature



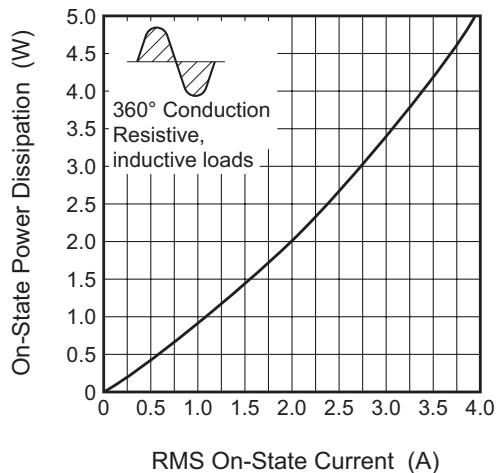
Maximum Transient Thermal Impedance Characteristics (Junction to case)



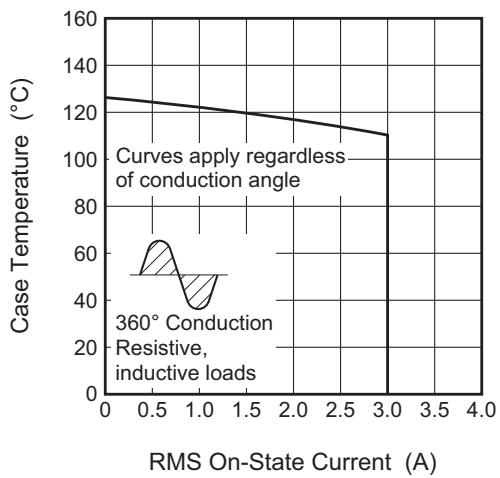
Maximum Transient Thermal Impedance
Characteristics (Junction to ambient)



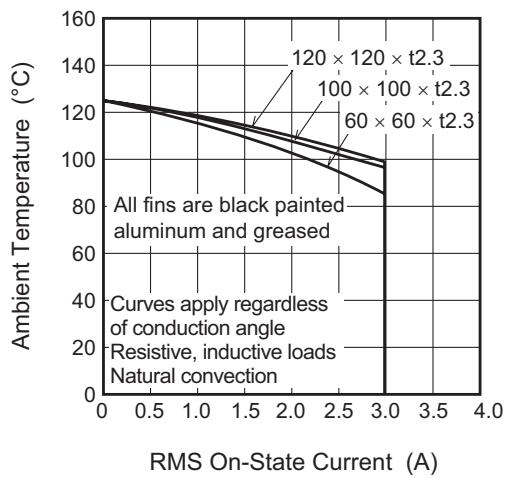
Maximum On-State Power Dissipation



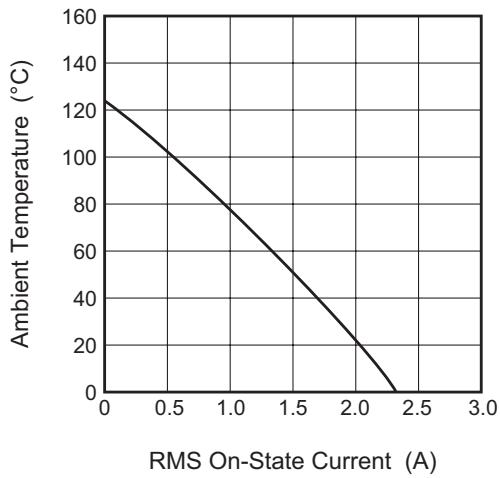
Allowable Case Temperature vs.
RMS On-State Current



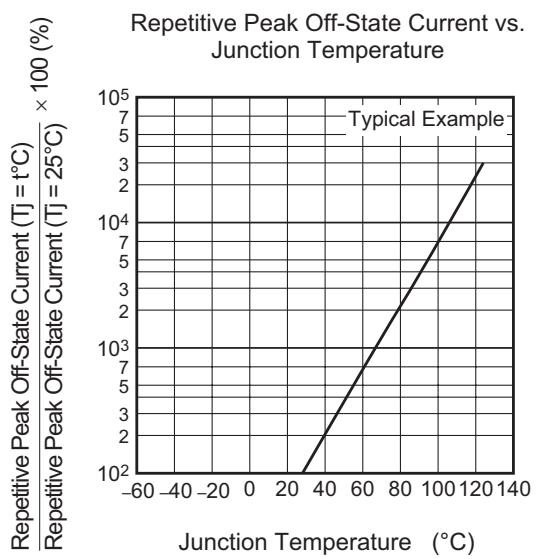
Allowable Ambient Temperature vs.
RMS On-State Current

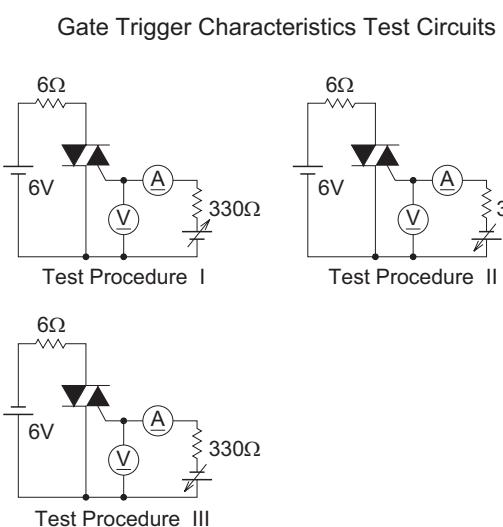
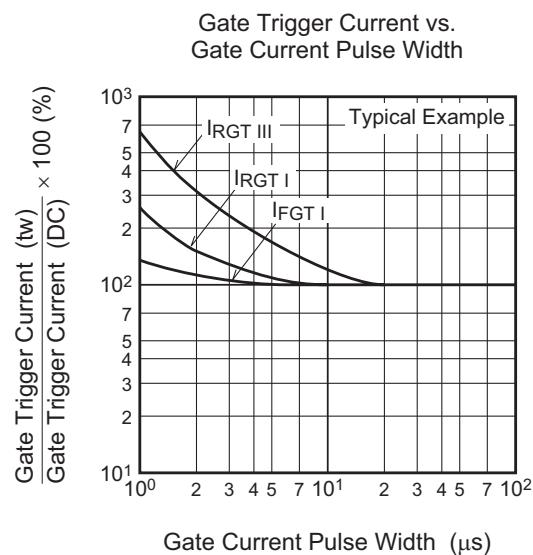
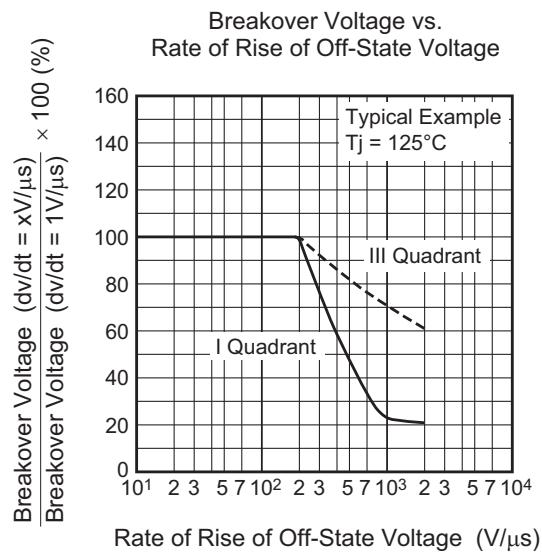
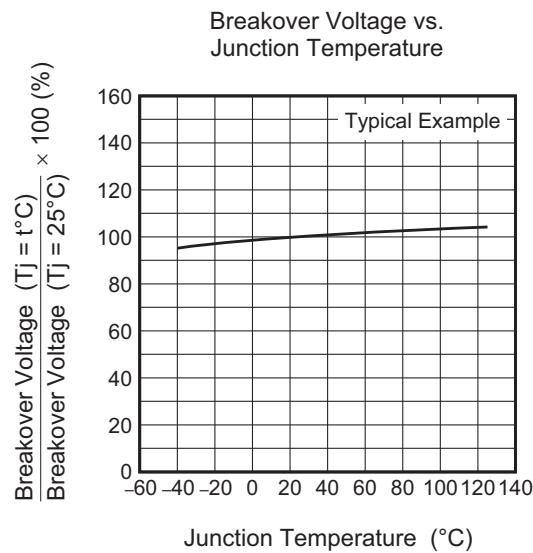
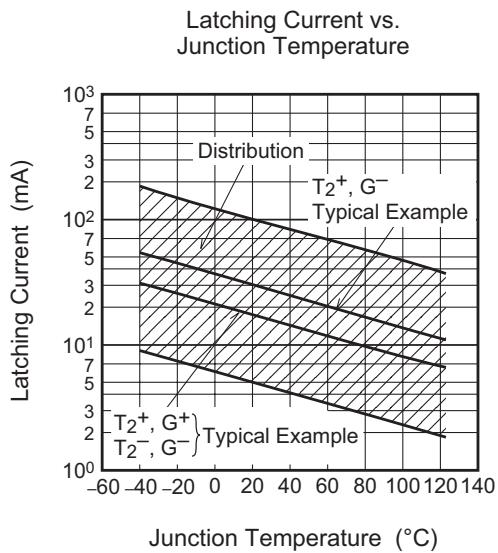
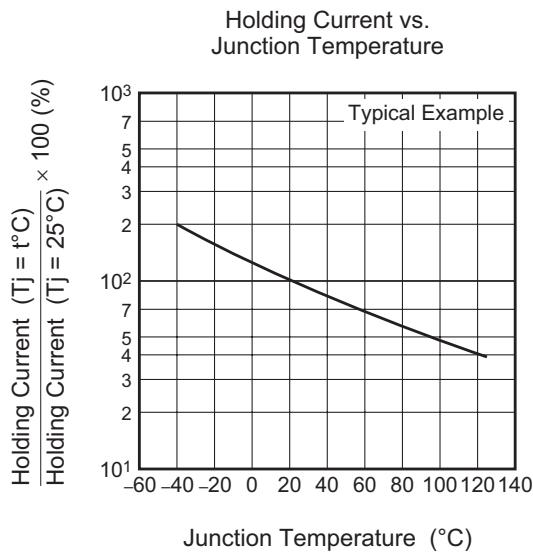


Allowable Ambient Temperature vs.
RMS On-State Current



Repetitive Peak Off-State Current vs.
Junction Temperature





Package Dimensions

TO-220FN																																																												
EIAJ Package Code	JEDEC Code	Mass (g) (reference value)	Lead Material																																																									
—	—	2.0	Cu alloy																																																									
<p>3D perspective view of the TO-220FN package. Dimensions shown are: Top width = 10 ± 0.3 mm, Top height = 6.5 ± 0.3 mm, Lead thickness = 0.75 ± 0.15 mm, Lead pitch = 2.54 ± 0.25 mm, Lead height = 14 ± 0.5 mm, Lead side height = 3.6 ± 0.2 mm, Lead side width = 1.1 ± 0.2 mm, Lead side thickness = 1.1 ± 0.2 mm, Lead side gap = 0.75 ± 0.15 mm, Lead side bottom gap = 2.54 ± 0.25 mm, and Lead side top gap = 2.54 ± 0.25 mm.</p>		<p>Front view of the TO-220FN package. Dimensions shown are: Total width = 2.8 ± 0.2 mm and Total height = 4.5 ± 0.2 mm.</p>	<p>Side view of the TO-220FN package.</p>																																																									
<p>Bottom view of the TO-220FN package. Dimensions shown are: Total width = 2.6 ± 0.2 mm and Total height = 4.5 ± 0.2 mm.</p>				<table border="1"> <thead> <tr> <th>Symbol</th> <th colspan="3">Dimension in Millimeters</th> </tr> <tr> <th></th> <th>Min</th> <th>Typ</th> <th>Max</th> </tr> </thead> <tbody> <tr> <td>A</td> <td></td> <td></td> <td></td> </tr> <tr> <td>A₁</td> <td></td> <td></td> <td></td> </tr> <tr> <td>A₂</td> <td></td> <td></td> <td></td> </tr> <tr> <td>b</td> <td></td> <td></td> <td></td> </tr> <tr> <td>D</td> <td></td> <td></td> <td></td> </tr> <tr> <td>E</td> <td></td> <td></td> <td></td> </tr> <tr> <td>e</td> <td></td> <td></td> <td></td> </tr> <tr> <td>x</td> <td></td> <td></td> <td></td> </tr> <tr> <td>y</td> <td></td> <td></td> <td></td> </tr> <tr> <td>y₁</td> <td></td> <td></td> <td></td> </tr> <tr> <td>ZD</td> <td></td> <td></td> <td></td> </tr> <tr> <td>ZE</td> <td></td> <td></td> <td></td> </tr> </tbody> </table>	Symbol	Dimension in Millimeters				Min	Typ	Max	A				A ₁				A ₂				b				D				E				e				x				y				y ₁				ZD				ZE			
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Note 1) The dimensional figures indicate representative values unless otherwise the tolerance is specified.

Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Plastic Magazine (Tube)	50	Type name +RA	BCR3KM-12RA
Lead form	Plastic Magazine (Tube)	50	Type name +RA – Lead forming code	BCR3KM-12RA-A8

Note : Please confirm the specification about the shipping in detail.

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_{T(RMS)}$	3.0	A	Commercial frequency, sine full wave 360° conduction, $T_c = 136^\circ\text{C}$
Surge on-state current	I_{TSM}	30	A	60Hz sinewave 1 full cycle, peak value, non-repetitive
I^2t for fusing	I^2t	3.7	A^2s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P_{GM}	3	W	
Average gate power dissipation	$P_{G(AV)}$	0.3	W	
Peak gate voltage	V_{GM}	6	V	
Peak gate current	I_{GM}	0.5	A	
Junction temperature	T_j	- 40 to +150	$^\circ\text{C}$	
Storage temperature	T_{stg}	- 40 to +150	$^\circ\text{C}$	
Mass	—	2.0	g	
Isolation voltage	V_{iso}	2000	V	$T_a = 25^\circ\text{C}$, AC 1 minute, $T_1 \cdot T_2 \cdot G$ terminal to case

Notes: 1. Gate open.

Electrical Characteristics

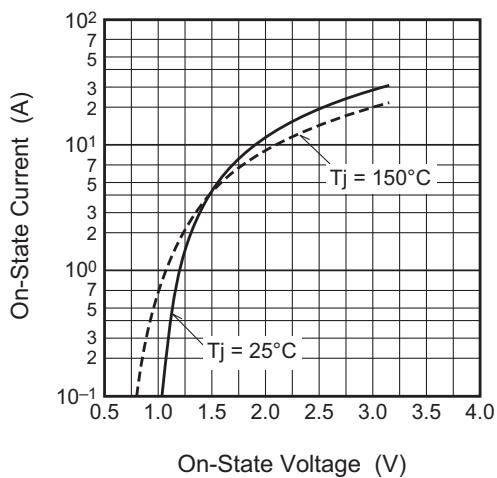
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak off-state current	I_{DRM}	—	—	2.0	mA	$T_j = 150^\circ\text{C}$, V_{DRM} applied
On-state voltage	V_{TM}	—	—	1.5	V	$T_c = 25^\circ\text{C}$, $I_{TM} = 4.5$ A, Instantaneous measurement
Gate trigger voltage ^{Note2}	I	$V_{FGT\ I}$	—	1.5	V	$T_j = 25^\circ\text{C}$, $V_D = 6$ V, $R_L = 6$ Ω , $R_G = 330$ Ω
	II	$V_{RGT\ I}$	—	1.5	V	
	III	$V_{RGT\ III}$	—	1.5	V	
Gate trigger current ^{Note2}	I	$I_{FGT\ I}$	—	15 ^{Note3}	mA	$T_j = 25^\circ\text{C}$, $V_D = 6$ V, $R_L = 6$ Ω , $R_G = 330$ Ω
	II	$I_{RGT\ I}$	—	15 ^{Note3}	mA	
	III	$I_{RGT\ III}$	—	15 ^{Note3}	mA	
Gate non-trigger voltage	V_{GD}	0.2/0.1	—	—	V	$T_j = 125^\circ\text{C}/150^\circ\text{C}$, $V_D = 1/2V_{DRM}$
Thermal resistance	$R_{th(j-c)}$	—	—	4.0	$^\circ\text{C/W}$	Junction to case ^{Note4}
Thermal resistance	$R_{th(j-a)}$	—	—	50	$^\circ\text{C/W}$	Junction to ambient

Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

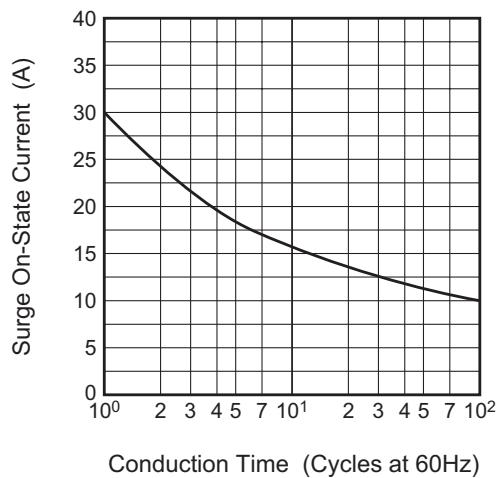
3. High sensitivity ($I_{GT} \leq 10$ mA) is also available. (I_{GT} item: 1)

4. The contact thermal resistance $R_{th(c-f)}$ in case of greasing is 0.5°C/W .

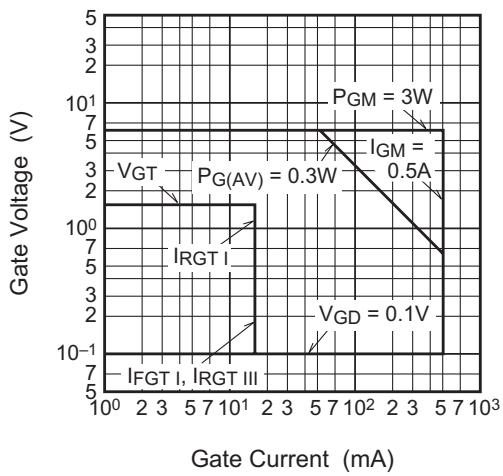
Maximum On-State Characteristics



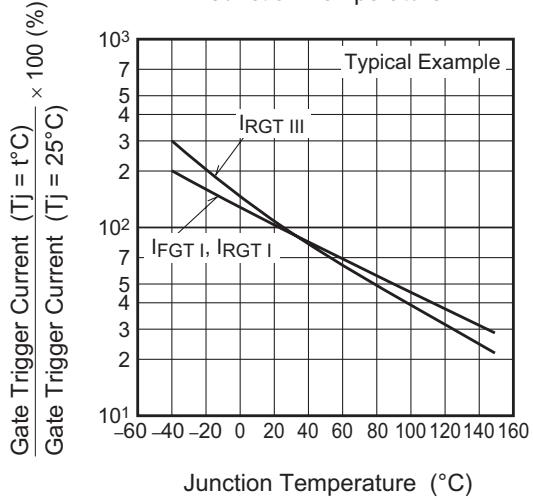
Rated Surge On-State Current



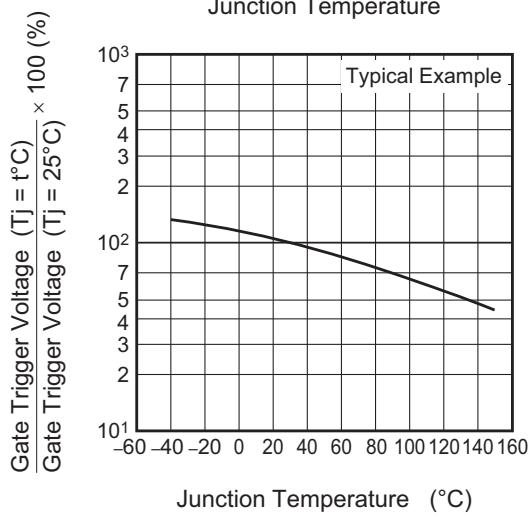
Gate Characteristics (I, II and III)



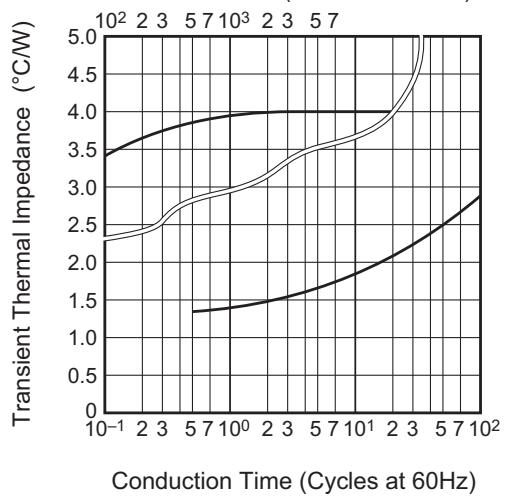
Gate Trigger Current vs. Junction Temperature



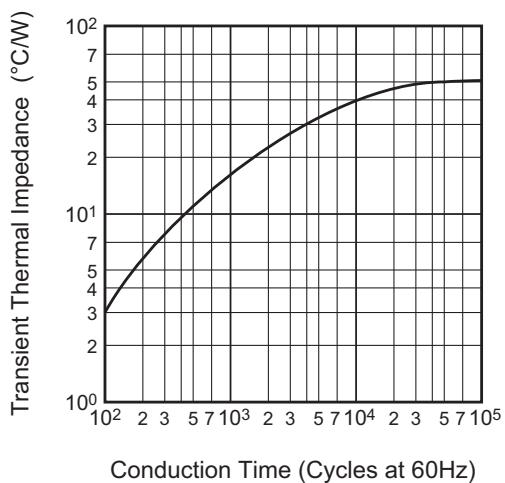
Gate Trigger Voltage vs. Junction Temperature



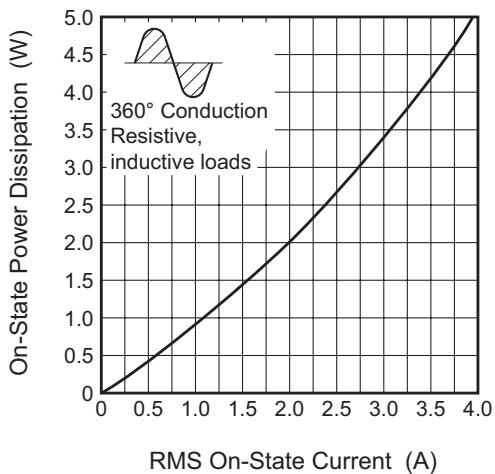
Maximum Transient Thermal Impedance Characteristics (Junction to case)



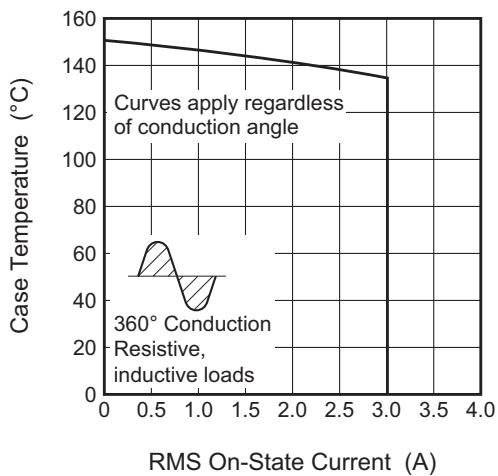
Maximum Transient Thermal Impedance Characteristics (Junction to ambient)



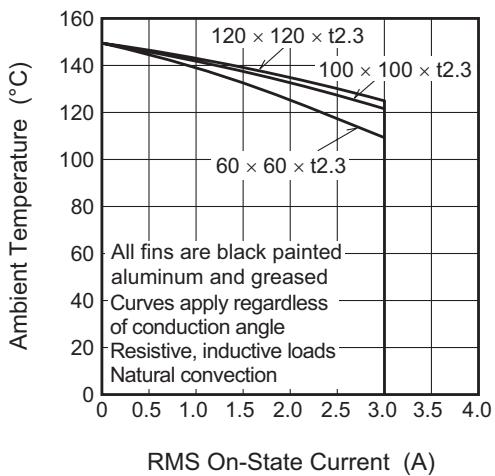
Maximum On-State Power Dissipation



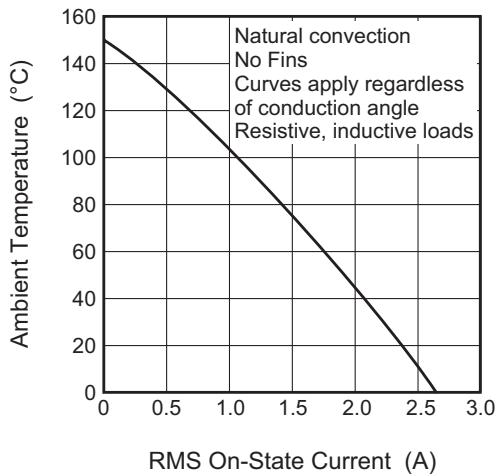
Allowable Case Temperature vs. RMS On-State Current



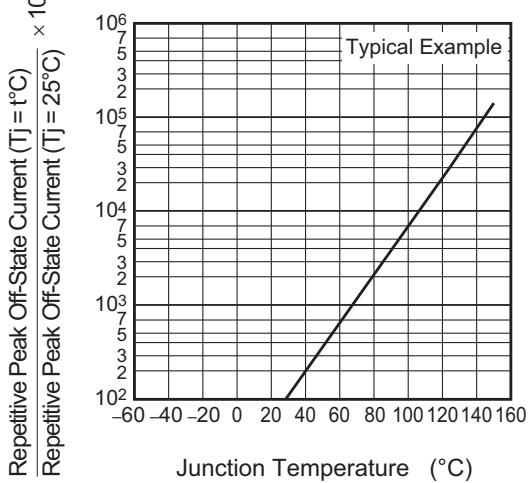
Allowable Ambient Temperature vs. RMS On-State Current



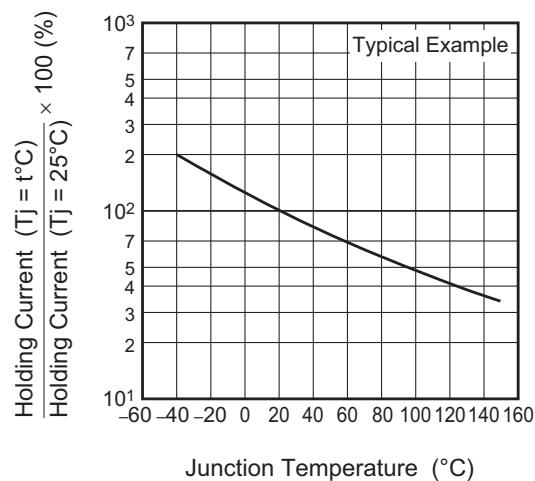
Allowable Ambient Temperature vs. RMS On-State Current



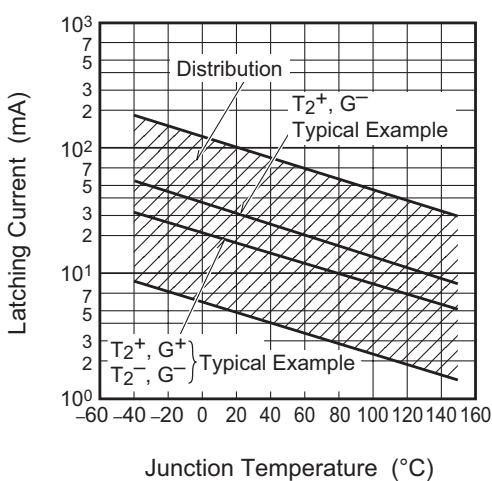
Repetitive Peak Off-State Current vs. Junction Temperature



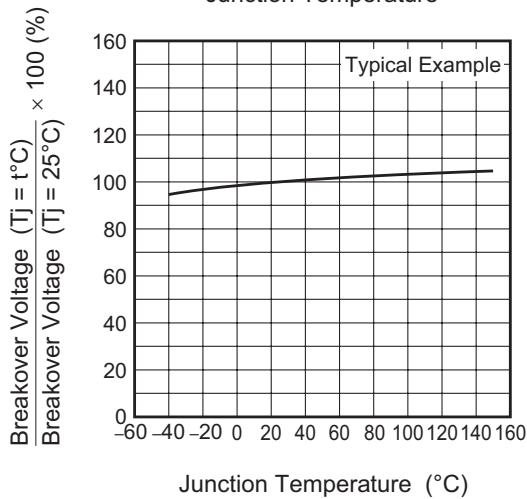
Holding Current vs.
Junction Temperature



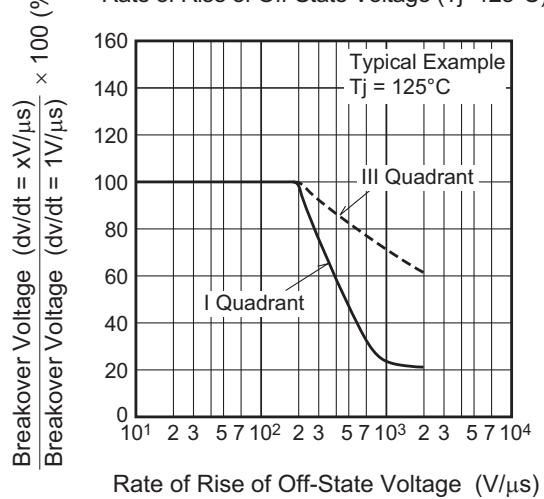
Latching Current vs.
Junction Temperature



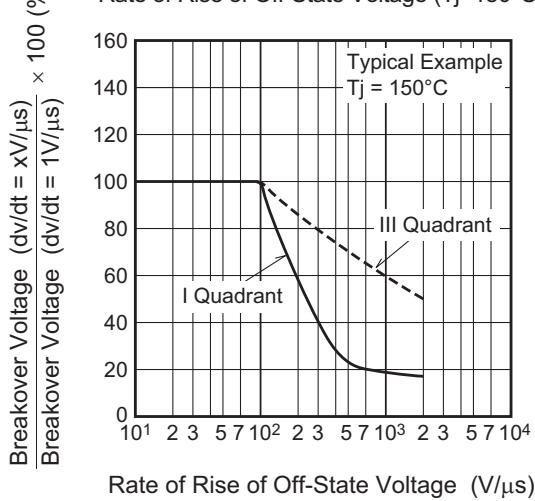
Breakover Voltage vs.
Junction Temperature



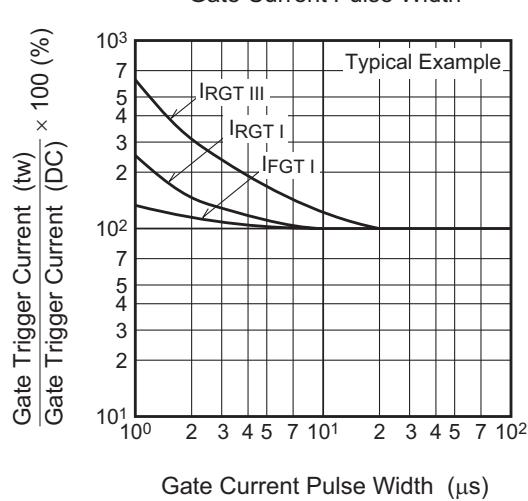
Breakover Voltage vs.
Rate of Rise of Off-State Voltage ($T_j=125^\circ\text{C}$)



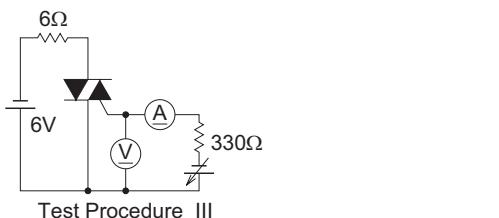
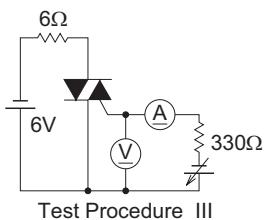
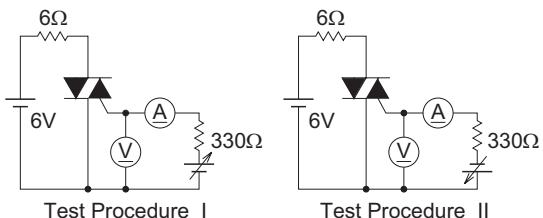
Breakover Voltage vs.
Rate of Rise of Off-State Voltage ($T_j=150^\circ\text{C}$)



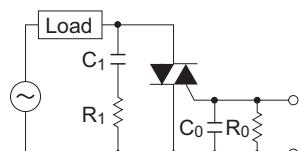
Gate Trigger Current vs.
Gate Current Pulse Width



Gate Trigger Characteristics Test Circuits



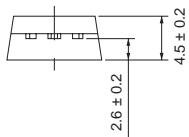
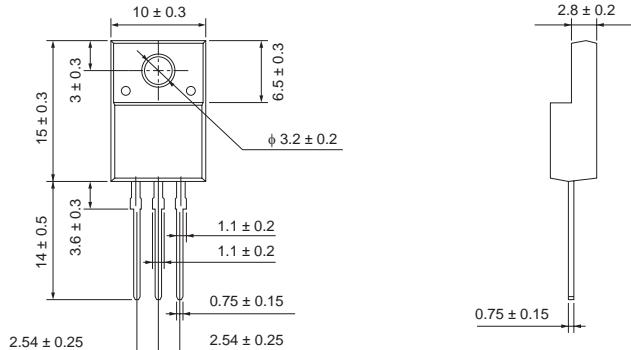
Recommended Circuit Values Around The Triac



$C_1 = 0.1 \text{ to } 0.47 \mu\text{F}$ $C_0 = 0.1 \mu\text{F}$
 $R_1 = 47 \text{ to } 100 \Omega$ $R_0 = 100 \Omega$

TO-220FN

EIAJ Package Code	JEDEC Code	Mass (g) (reference value)	Lead Material
—	—	2.0	Cu alloy



Note 1) The dimensional figures indicate representative values unless otherwise the tolerance is specified.

Symbol	Dimension in Millimeters		
	Min	Typ	Max
A	—	—	—
A ₁	—	—	—
A ₂	—	—	—
b	—	—	—
D	—	—	—
E	—	—	—
e	—	—	—
x	—	—	—
y	—	—	—
y ₁	—	—	—
ZD	—	—	—
ZE	—	—	—

Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Plastic Magazine (Tube)	50	Type name +RB	BCR3KM-12RB
Lead form	Plastic Magazine (Tube)	50	Type name +RB – Lead forming code	BCR3KM-12RB-A8

Note : Please confirm the specification about the shipping in detail.